PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4335090

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
AHMED KAMEL SADEK	03/20/2017
NACHIAPPAN VALLIAPPAN	02/14/2017
TAMER ADEL KADOUS	03/16/2017
CHIRAG SURESHBHAI PATEL	03/21/2017
TAO LUO	03/17/2017

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	15250765	

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 7036217140

Email: meo.docket@mg-ip.com

Correspondent Name: MUNCY, GEISSLER, OLDS & LOWE, P.C./QC

Address Line 1: 4000 LEGATO ROAD, SUITE 310

Address Line 4: FAIRFAX, VIRGINIA 22033

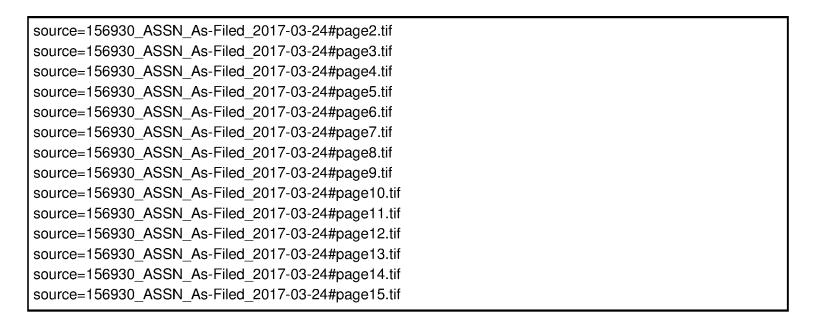
ATTORNEY DOCKET NUMBER: QC156930	
NAME OF SUBMITTER:	SAMANTHA PITTENGER
SIGNATURE:	/Samantha Pittenger/
DATE SIGNED:	03/24/2017

Total Attachments: 15

source=156930_ASSN_As-Filed_2017-03-24#page1.tif

PATENT REEL: 041721 FRAME: 0288

504288409



WHEREAS, WE,

- 1. Ahmed Kamel SADEK, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA,
- 2. Nachiappan VALLIAPPAN, a citizen of India, having a mailing address located at 1235 Wildwood Ave, Apt. 86, Sunnyvale, CA 94089 and a resident of San Diego, CA
- 3. Tamer Adel KADOUS, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA,
- 4. Chirag Sureshbhai PATEL, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA,
- 5. Tao LUO, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to INTER-ACCESS TERMINAL UNBLOCKING AND ENHANCED CONTENTION FOR CO-EXISTENCE ON A SHARED COMMUNICATION MEDIUM (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 15/250,765 filed August 29, 2016, Qualcomm Reference No. 156930, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 62/212,344, filed August 31, 2015, Qualcomm

QUALCOMM Ref. No. 156930 Page 2 of 3

Reference No. 156930P1, together with U.S. Provisional Application No(s). 62/212,096, filed August 31, 2015, Qualcomm Reference No. 156931P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance:

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _	San Diegy, on	03-20-17 DATE	Ahmed Kamel SADEK
	, on		
	200.1110.1	DATE	Nachiappan VALLIAPPAN
Done at _	LOCATION , on	DATE	Tamer Adel KADOUS
Done at _	LOCATION on	DATE	Chirag Sureshbhai PATEL
Done at _	, on _	DATE	Tao LUO

WHEREAS, WE,

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- 4. Chirag Sureshbhai PATEL, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA,
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Reference No. 156930P1, together with U.S. Provisional Application No(s). 62/212,096, filed August 31, 2015, Qualcomm Reference No. 156931P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

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AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance:

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

PATENT

QUALCOMM Ref. No. 156930

Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at, on	Done at		_, on	
Done at, on LOCATION DATE Nachiappan VALLIAPI Done at, on LOCATION DATE Tamer Adel KADOUS Done at, on LOCATION DATE Chirag Sureshbhai PAT				Ahmed Kamel SADEK
Done at, onChirag Sureshbhai PAT	Done at 2	Santa Clasa Location	on <u>(2 14 2017)</u> DATE	Nachiappan VALLIAPPAN
LOCATION DATE Chirag Sureshbhai PAT	Done at _	LOCATION	on	Tamer Adel KADOUS
Done at, on	Done at _	LOCATION		Chirag Sureshbhai PATEL
LOCATION DATE Too I I TO	Done at _	LOCATION		Tao LUO

WHEREAS, WE,

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- 4. Chirag Sureshbhai PATEL, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA,
- 5. Tao LUO, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA,

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QUALCOMM Ref. No. 156930 Page 2 of 3

Reference No. 156930P1, together with U.S. Provisional Application No(s). 62/212,096, filed August 31, 2015, Qualcomm Reference No. 156931P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

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PATENT QUALCOMM Ref. No. 156930 Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		, on		
	LOCATION		DATE	Ahmed Kamel SADEK
Done at _	LOCATION	_, on	P. A.TPE	NT - 2. WYAR TAANNO ANY
	LOCATION		DATE	Nachiappan VALLIAPPAN
Done at _	Su Diès	, on	3-16-17	Tamer Adel KADOUS
Done at _	LOCATION	, on	DATE	China Company in Partition
	LOCATION		DATE	Chirag Sureshbhai PATEL
Done at _	1 0 0 1 m 0 1	, on	DATE	
	LOCATION		{3Δ°Γ₩	Tanilin

WHEREAS, WE,

- 1. Ahmed Kamel SADEK, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA,
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- 4. Chirag Sureshbhai PATEL, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA,
- 5. **Tao LUO**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to INTER-ACCESS TERMINAL UNBLOCKING AND ENHANCED CONTENTION FOR CO-EXISTENCE ON A SHARED COMMUNICATION MEDIUM (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

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Reference No. 156930P1, together with U.S. Provisional Application No(s). 62/212,096, filed August 31, 2015, Qualcomm Reference No. 156931P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

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Done at		, on	
	LOCATION	DATE	Ahmed Kamel SADEK
Done at	LOCATION ,	on	Nachiappan VALLIAPPAN
Done at	LOCATION ,	OnDATE	Tamer Adel KADOUS
Done at	SAN DIECS, LOCATION	on 3 2 h	Chirag Sureshbhai PATEL
Done at	LOCATION ,	on	Tao LUO

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PATENT QUALCOMM Ref. No. 156930 Page 3 of 3

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Done at		, on	<u> </u>
_	LOCATION	_, on DATE	Ahmed Kamel SADEK
Done at _	See Marie	_, on	
	LOCATION	DATE	Nachiappan VALLIAPPAN
Done at _		_, on	
	LOCATION	DATE	Tamer Adel KADOUS
Done at _		on	
	LOCATION	DATE	Chirag Sureshbhai PATEL
Done at	Sandra	, on 63/17/20)	
· · <u> </u>	LOCATION	DATE	Tao LUO

PATENT REEL: 041721 FRAME: 0304

RECORDED: 03/24/2017